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## APPLICANTS

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\*\* CONTINUING DATA \*\*\*\*\* HP  
*None*

\*\* FOREIGN APPLICATIONS \*\*\*\*\* HP  
 JAPAN 2002-226340 08/02/2002  
*YES*

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## TITLE

Solder ball assembly, a method for its manufacture, and a method of forming solder bumps

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